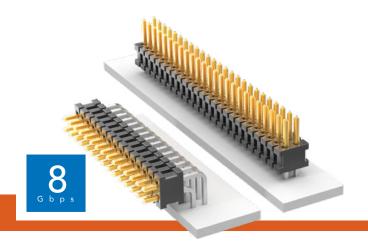
# THROUGH-HOLE MICRO HEADER

(1.27 mm) .050" PITCH • FTSH SERIES



**FTSH Board Mates:** 

CLP, FLE

Cable Mates: FFSD, FFTP

### **SPECIFICATIONS**

Insulator Material: Black Liquid Crystal Polymer
Terminal Material: Phosphor Bronze Plating: Sn or Au over 50 µ" (1.27 µm) Ni Current Rating (FTSH/CLP): 3.4 A per pin (2 pins powered) Operating Temp Range: -55 °C to +125 °C

### **PROCESSING**

Lead-Free Solderable:

### **LOCKING CLIP**

For single mating cycle with the FFSD. PC BOARD □ 00000 Specify -LC after tail option. Lead Style -01 and 10 pins/row minimum.

5-9 pins/row not available in combination with keying shroud (-K).

## ALSO AVAILABLE MOQ Required

Molded Pick & Place pads Other platings



### Notes:

non-returnable.

See SFM/TFM for positive alignment feature.



02

thru

50

Specify LEAD **STYLE** from

LEAD

STYLE

= Gold flash on post, Matte Tin on tail chart

> -L = 10 µ" (0.25 µm) Gold on post, Matte Tin on tail

**PLATING** 

**OPTION** 

# Leave blank for

-"XXX" = Polarized Position (Specify position of omitted pin) (Not available with -EX options)

OPTION

Right-angle

Leave blank for straight tail

TAIL

OPTION

-RA = Right-angle

## **OPTIONS**

**-ES** = End Shroud (Style -02 & -03) 9 pins/row minimum

### -EP

End Shroud with Guide Post (Style –02 & –03) 9 pins/row minimum

**-EL** = End Shroud with Board Lock (Style -02 & -03) 9 pins/row

### –EJ

= Ejector Shroud (Style –01 only) 10 pins/row minimum 25 pins/row maximum -RA not available

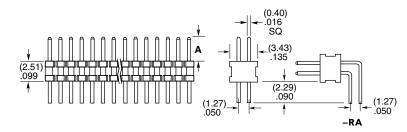
### -K

= Keying Shroud for mating with FFSD (Style –01 only, 05 thru 25 pins/row only. 13, 17, 20 & 25 only with -EJ option)

No. of positions x (1.27) .050 + <b>Z</b> →		
(4.78) -188		
EV ORTION CHOWN		

←No. of positions x (1.27) .050 →	¥
	(3.43)
	.135

OPTION	Z
-ES	(1.55) .061
–EJ	(15.77) .621
-EP	(5.87) .231
-EL	((6.53) .257



LEAD STYLE	A	MATES WITH
-01	(3.05) .120	FFSD
-02	(1.91) .075	FLE
-03	(1.65) .065	CLP-D
-04	(3.81) .150	N/A



Some sizes, styles and options are non-standard,



